



## ET5H4XX - High Input Very-Low I<sub>Q</sub> 500mA LDO

### General Description

ET5H4XX series are the high input very low I<sub>Q</sub> 500mA LDO with enable function that operates from 3V~16V, is designed specifically for portable battery-powered applications which require ultra-low quiescent current. The very-low consumption of type 1.0µA ensures long battery life and dynamic transient boost feature improves device transient response for wireless communication applications.

ET5H4XX series are offered SOT89-3, SOT89-5, SOT23-5, SOT23-3, DFN4(1x1) packages.

### Features

- Wide Input Voltage Range: 3.0V to 16V
- Up to 500mA Load Current
- Very low I<sub>Q</sub>: 1.0µA typical
- Fixed Output Voltage are 3.0V, 3.3V, 3.6V, 5.0V, etc
- Low dropout: 765mV @ 500mA /V<sub>OUT</sub>=3.3V
- Excellent Load/Line Transient Response
- High Ripple Rejection: 60dB at 1KHz

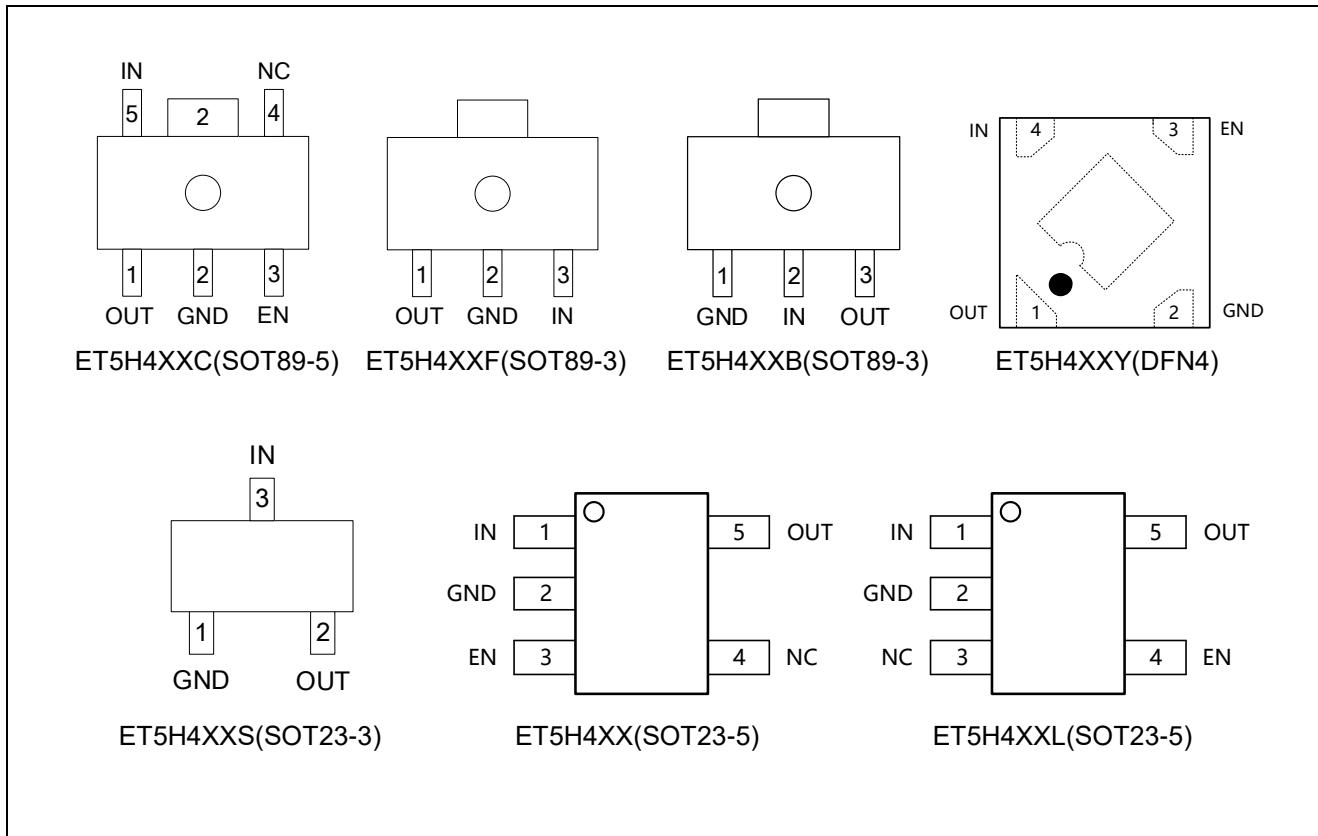
### Device information

ET 5H4    XX    X

<u>XX</u>	Output Voltage	<u>X</u>	Package	Packing Option	MSL
XX	Output Voltage For example, 33 is 3.3V output	Y	DFN4	Tape and Reel,10K	1
		B	SOT89-3	Tape and Reel,1K	3
		F	SOT89-3	Tape and Reel,1K	3
		C	SOT89-5	Tape and Reel,1K	3
		S	SOT23-3	Tape and Reel,3K	3
		L	SOT23-5	Tape and Reel,3K	3
		/	SOT23-5 (Default)	Tape and Reel,1K	3

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## Pin Configuration



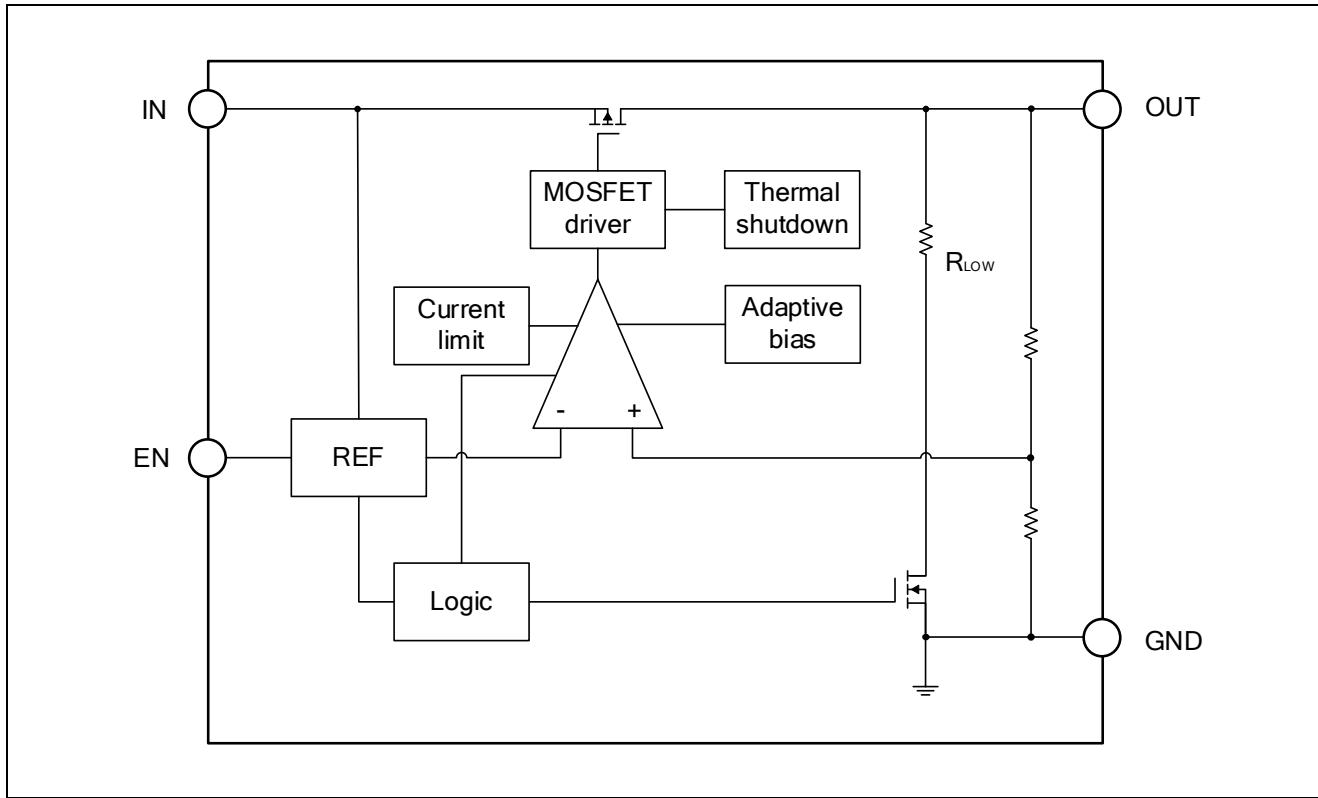
## Pin Function

Pin No.							Pin Name	Pin Function
SOT89-5	SOT89-3		SOT23-3	SOT23-5		DFN4		
XXC	XXB	XXF	XXS	XX	XXL	XXY		
2	1	2	1	2	2	2	GND	Ground.
5	2	3	3	1	1	4	IN	Supply input pin.
1	3	1	2	5	5	1	OUT	Output pin.
3				3	4	3	EN	Enable control input, active high.
4				4	3		NC	No connection.

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## Block Diagram



## Functional Description

### Input Capacitor

A  $1\mu\text{F} \sim 10\mu\text{F}$  ceramic capacitor is recommended to connect between  $V_{IN}$  and GND pins to decouple input power supply glitch and noise. The amount of the capacitance may be increased without limit. This input capacitor must be located as close as possible to the device to assure input stability and less noise. For PCB layout, a wide copper trace is required for both  $V_{IN}$  and GND.

### Output Capacitor

An output capacitor is required for the stability of the LDO. The recommended output capacitance is from  $1\mu\text{F}$  to  $10\mu\text{F}$ , Equivalent Series Resistance (ESR) is from  $5\text{m}\Omega$  to  $100\text{m}\Omega$ , and temperature characteristics are X7R or X5R. Higher capacitance values help to improve load/line transient response. The output capacitance may be increased to keep low undershoot/overshoot. Place output capacitor as close as possible to OUT and GND pins.

### Enable

The ET5H4XX delivers the output power when it is set to enable state. When it works in disable state, there is no output power and the operation quiescent current is almost zero. The enable pin (EN) is active high.

### Dropout Voltage

The ET5H4XX uses a PMOS pass transistor to achieve low dropout. When  $(V_{IN} - V_{OUT})$  is less than the dropout voltage ( $V_{DROP}$ ), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the  $R_{DS(ON)}$  of the PMOS pass element.  $V_{DROP}$  scales approximately with output current because the PMOS device behaves like a resistor in dropout mode. As with any linear regulator, PSRR and transient response degrade as  $(V_{IN} - V_{OUT})$  approaches dropout operation.

### Thermal Shutdown

Thermal shutdown protection disables the output when the junction temperature rises to approximately  $160^\circ\text{C}$ . Disabling the device eliminates the power dissipated by the device, allowing the device to cool. When the junction temperature cools to approximately  $140^\circ\text{C}$ , the output circuitry is again enabled.

Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits regulator dissipation, protecting the LDO from damage as a result of overheating. Activating the thermal shutdown feature usually indicates excessive power dissipation as a result of the product of the  $(V_{IN} - V_{OUT})$  voltage and the load current. For reliable operation, limit junction temperature to  $150^\circ\text{C}$  maximum.

### Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction to ambient thermal resistance.

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For recommended operating condition specifications the maximum junction temperature is 150°C and  $T_A$  is the ambient temperature. The junction to ambient thermal resistance,  $\theta_{JA}$  is layout dependent.

For SOT89-5 package, the thermal resistance,  $\theta_{JA}$  is 80°C/W on the test board. The maximum power dissipation at  $T_A = 25^\circ\text{C}$  can be calculated by the following formula:

$$P_{D(\text{MAX})} = (150^\circ\text{C} - 25^\circ\text{C}) / (80^\circ\text{C}/\text{W}) = 1.562\text{W}$$
 for SOT89-5 package

## Current-Limit Protection

The ET5H4XX provides current limit function to prevent the device from damages during over-load or shorted-circuit condition. This current is detected by an internal sensing transistor.

## Layout Guidelines

- Place input and output capacitors as close to the device as possible.
- Use copper planes for device connections in order to optimize thermal performance.
- Place thermal vias around the device to distribute heat.
- Do not place a thermal via directly beneath the thermal pad. A via can wick solder or solder paste away from the thermal pad joint during the soldering process, leading to a compromised solder joint on the thermal pad.

## Absolute Maximum Ratings

Symbol	Rating	Value	Unit
$V_{IN}$	Input Voltage <sup>(1)</sup>	-0.3~20	V
$V_{OUT}$	Output Voltage	-0.3~6	V
$V_{EN}$	Chip Enable Input	-0.3~16	V
$T_{J(\text{MAX})}$	Maximum Junction Temperature	150	°C
$T_{STG}$	Storage Temperature	-65~150	°C
ESD <sup>(2)</sup>	HBM Capability	$\pm 2000$	V
	CDM Capability	$\pm 1500$	V
$I_{LU}$ <sup>(2)</sup>	Latch up Current Maximum Rating	$\pm 200$	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

**Note1.** Refer to Electrical Characteristics and Application Information for Safe Operating Area.

**Note2.** This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per EIA/JESD22-A114-A;

CDM tested per JESD22-C101;

Latch up Current Maximum Rating tested per JEDEC78.

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## Thermal Characteristics

Symbol	Package	Ratings	Value	Unit
$R_{\theta JA}$	SOT89-5	Thermal Characteristics, Thermal Resistance, Junction-to-Air	80	°C/W
	SOT89-3		135	
	SOT23-5		250	
	SOT23-3		360	
	DFN4		250	
Power Dissipation @25°C	SOT89-5	PCB board dimension: 40mm x 40mm (2layer) Copper :1OZ	1500	mW
	SOT89-3		920	
	SOT23-5		500	
	SOT23-3		350	
	DFN4		500	

## Recommended Operating Conditions

Symbol	Item	Rating	Unit
$V_{IN}$	Input Voltage	3.0 to 16	V
$I_{OUT}$	Output Current	0 to 500	mA
$T_A$	Operating Ambient Temperature	-40 to 85	°C
$C_{IN}$	Effective Input Ceramic Capacitor Value	1 to 10	µF
$C_{OUT}$	Effective Output Ceramic Capacitor Value	1 to 10	µF
ESR	Input and Output Capacitor Equivalent Series Resistance (ESR)	5 to 100	mΩ

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## Electrical Characteristics

( $V_{IN} = V_{OUT} + 2V$ ;  $I_{OUT} = 10mA$ ,  $C_{IN} = C_{OUT} = 1.0\mu F$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ C$ .)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
$V_{IN}$	Operating Input Voltage <sup>(3)</sup>		3.0		16	V
$V_{OUT}$	Output Voltage	$T_A = +25^\circ C$	-2%		+2%	V
		$-40^\circ C \leq T_A \leq 85^\circ C$	-3%		+3%	
$I_{Q\_ON}$	Quiescent Current	$I_{OUT} = 0mA$ , $T_A = 25^\circ C$		1	2	$\mu A$
$I_{Q\_OFF}$	Standby Current	$V_{EN} = 0V$ , $T_A = 25^\circ C$		0.1	1	$\mu A$
$Line_{REG}$	Line Regulation	$V_{IN} = V_{OUT} + 2V$ to 16V, $I_{OUT} = 10mA$ ( $\Delta V_{OUT}/\Delta V_{IN}/V_{out}$ )		0.05	0.20	%/V
$V_{DROP}$	Dropout Voltage <sup>(4)</sup>	$V_{OUT}=3.0V$ , $T_A = 25^\circ C$		770	1150	mV
		$V_{OUT}=3.3V$ , $T_A = 25^\circ C$		765	1125	
		$V_{OUT}=3.6V$ , $T_A = 25^\circ C$		760	1100	
		$V_{OUT}=5.0V$ , $T_A = 25^\circ C$		750	1075	
$Load_{REG}$	Load Regulation	$1mA \leq I_{OUT} \leq 500mA$ , $V_{IN} = V_{OUT} + 2V$ , $V_{OUT}=3.3V$ , $T_A = 25^\circ C$		30	60	mV
$I_{LMT}$	Current Limit	$V_{IN} = V_{OUT} + 2V$	550	900		mA
$V_{ENH}$	EN Pin Threshold Voltage	EN Input Voltage "H"	1.2			V
$V_{ENL}$	EN Pin Threshold Voltage	EN Input Voltage "L"			0.3	V
$I_{EN}$	EN Pin Current	$V_{EN} = 0\sim 16V$		1		$\mu A$
$PSRR$	Power Supply Rejection Ratio <sup>(5)</sup>	$f = 1 kHz$ , $V_{IN} = V_{OUT} + 2V$ $I_{OUT} = 20mA$		60		dB
$e_N$	Output Noise Voltage <sup>(5)</sup>	$V_{IN} = V_{OUT} + 2V$ , $I_{OUT} = 1mA$ , $f = 10Hz$ to 100KHz, $V_{OUT} = 3V$ , $C_{OUT} = 1\mu F$		120		$\mu V_{rms}$
$T_{SD}$	Thermal Shutdown Temperature <sup>(5)</sup>	Temperature Increasing from $T_A = +25^\circ C$		160		$^\circ C$
$T_{SDH}$	Thermal Shutdown Hysteresis <sup>(5)</sup>	Temperature Falling from $T_{SD}$		20		$^\circ C$

**Note3.** Here  $V_{IN}$  means internal circuit can work normal. If  $V_{IN} < V_{OUT}$ , Output voltage follows  $V_{IN}$  ( $I_{OUT} = 1mA$ ), circuit is safety.

**Note4.**  $V_{DROP}$  FT test method: test the  $V_{OUT}$  voltage at  $V_{SET} + V_{DROP MAX}$  with 500mA output current.

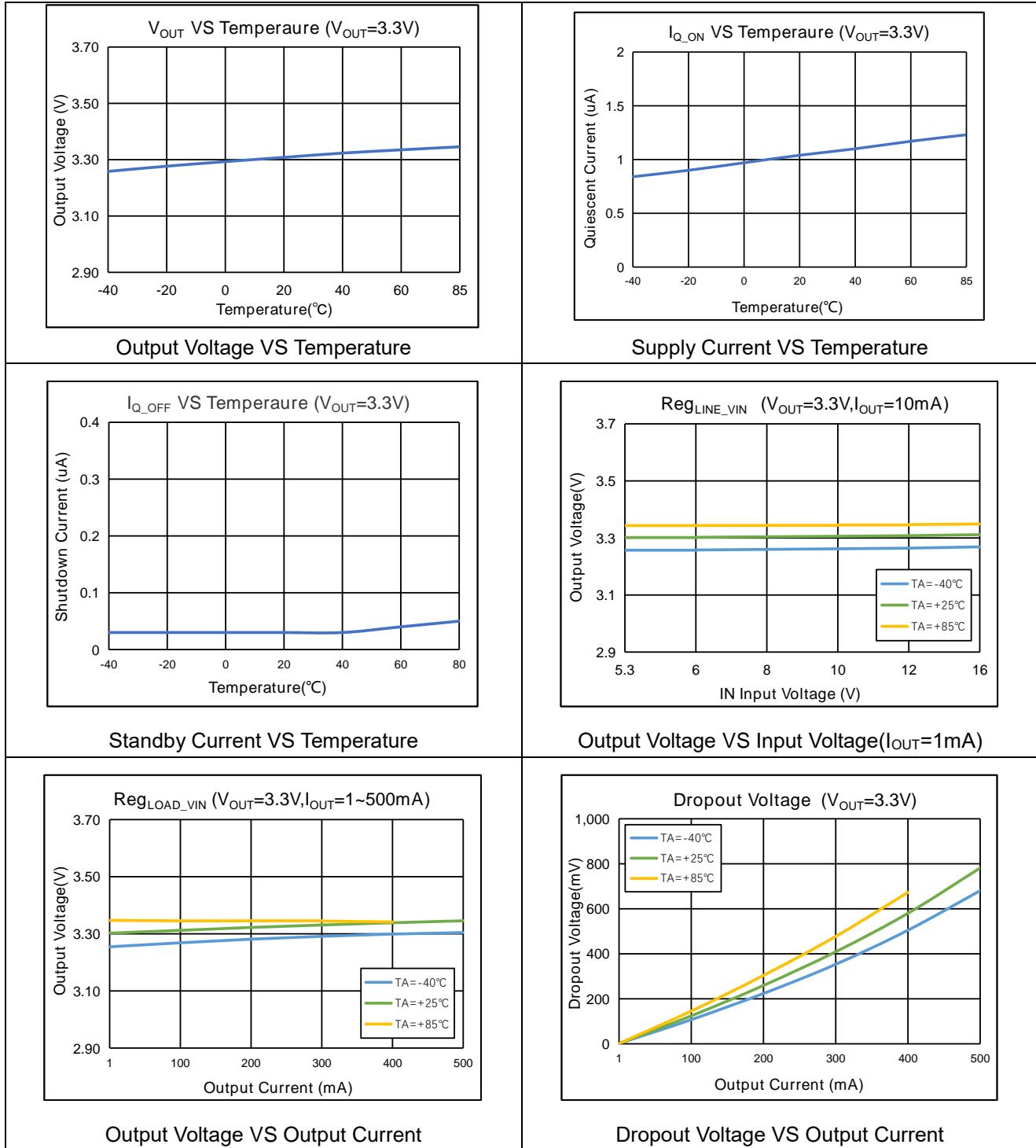
**Note5.** Guaranteed by design and characterization. not a FT item.

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## Typical Characteristics

### VOLTAGE VERSION 3.3V

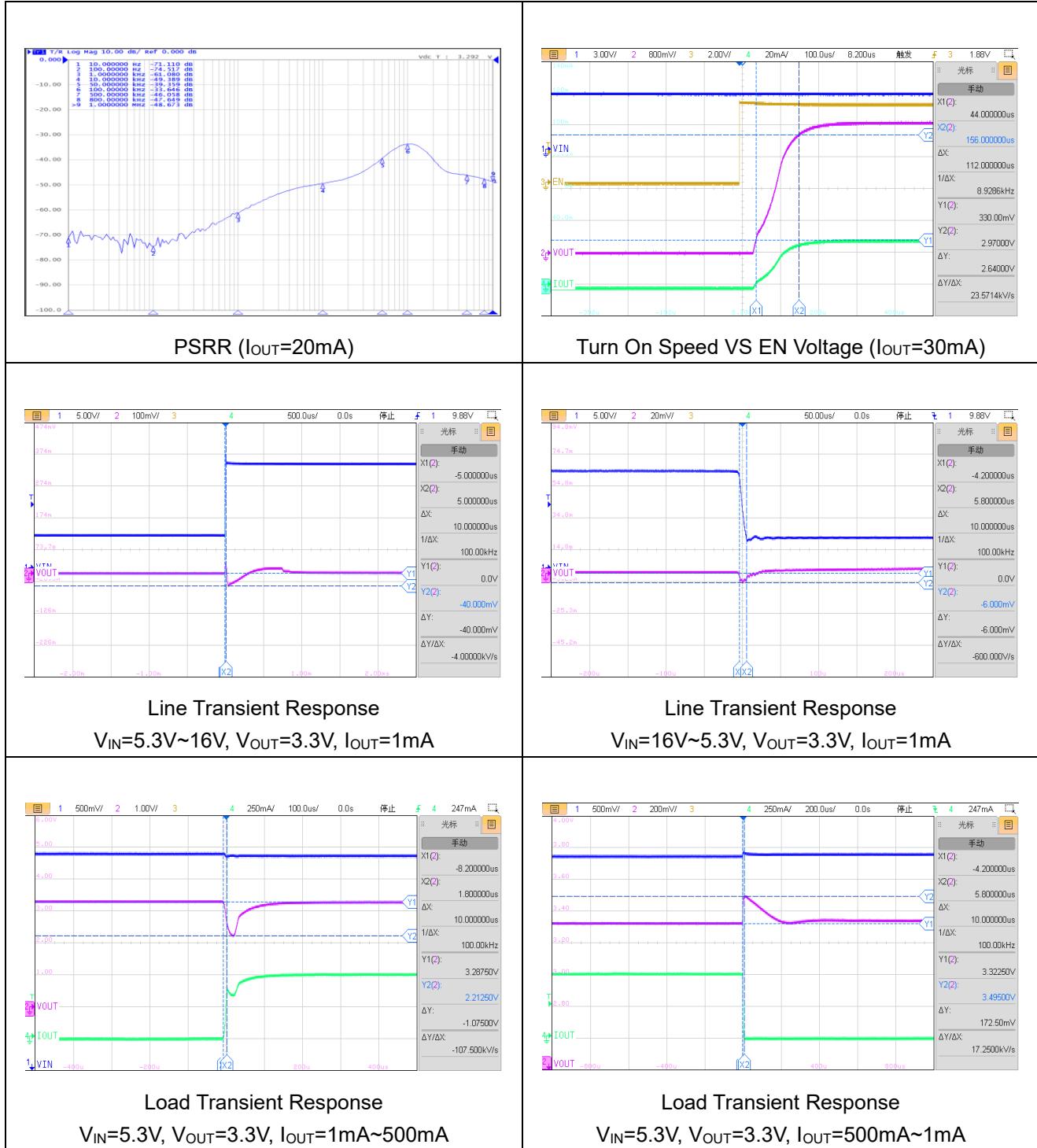
( $V_{IN} = V_{OUT} + 2V$ ,  $I_{OUT} = 10\text{mA}$ ,  $C_{IN} = C_{OUT} = 1.0\mu\text{F}$ , unless otherwise noted. Typical values are at  $T_A = +25^\circ\text{C}$ .)



## Typical Characteristics (Continued)

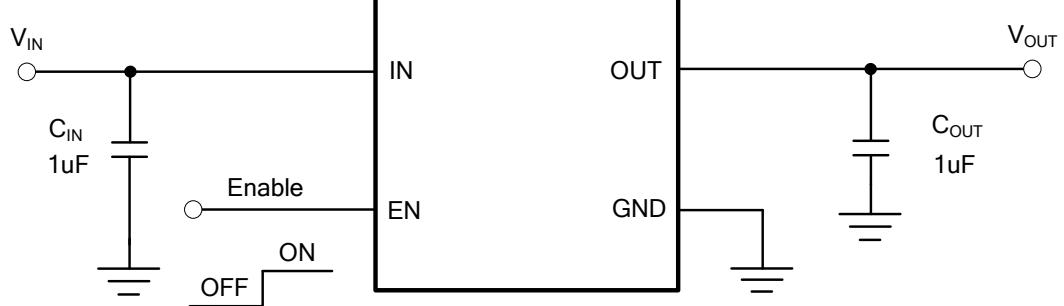
### VOLTAGE VERSION 3.3V

( $V_{IN} = V_{OUT} + 2V$ ,  $I_{OUT} = 10mA$ ,  $C_{IN} = C_{OUT} = 1.0\mu F$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .)

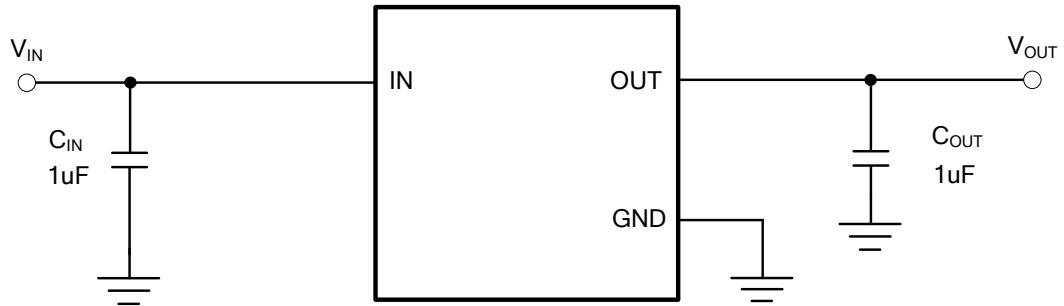


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## Application Circuits



Package With EN Function

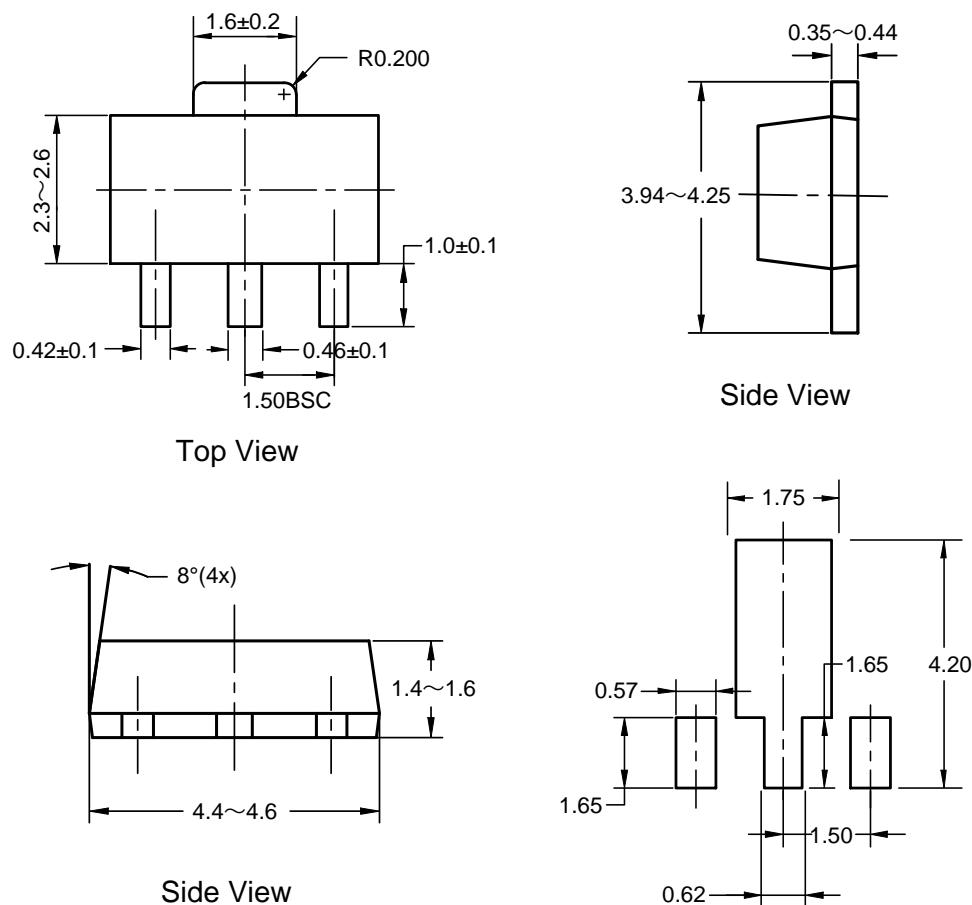


Package Without EN Function

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## Package Dimension

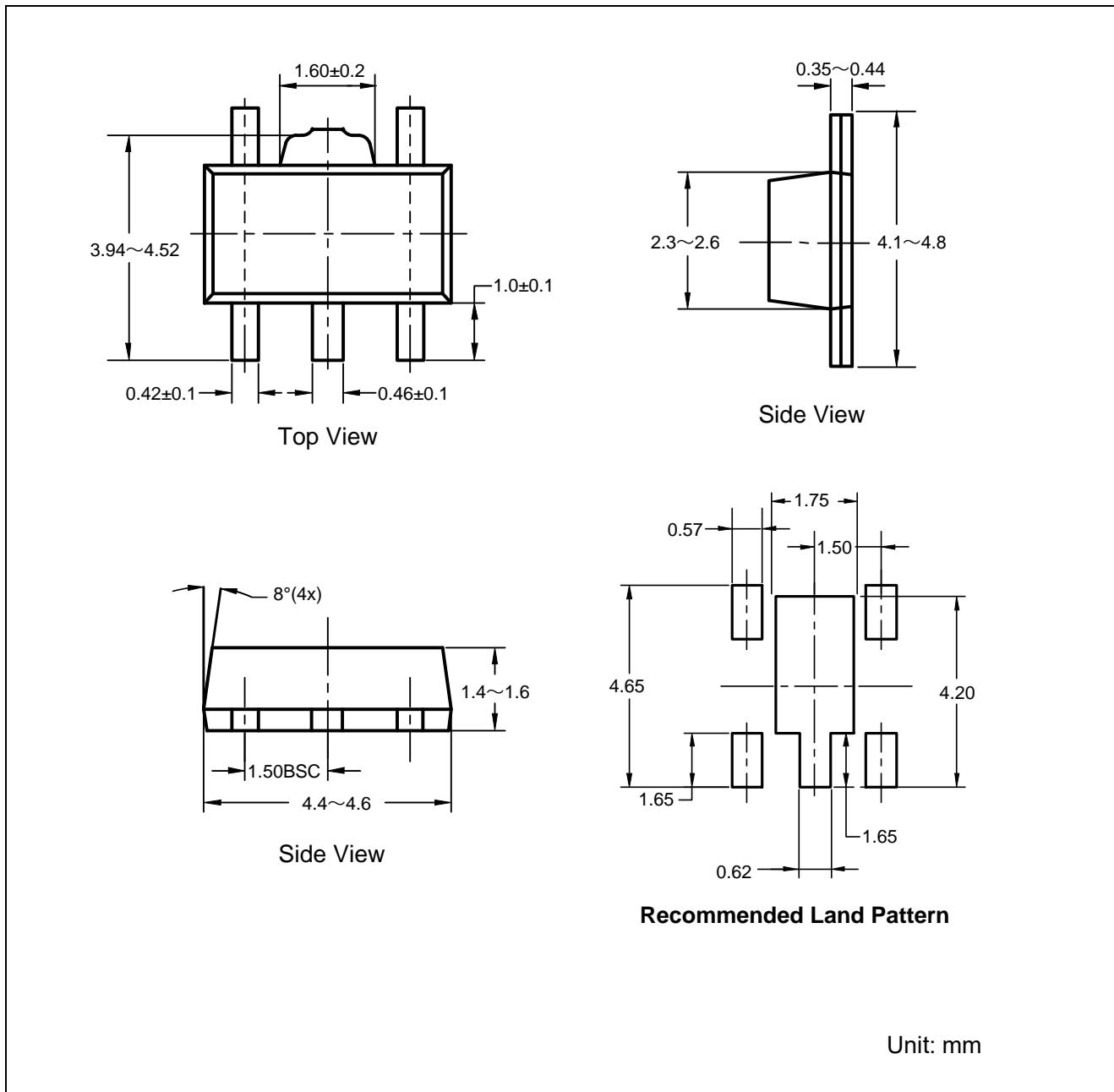
SOT89-3



Unit: mm

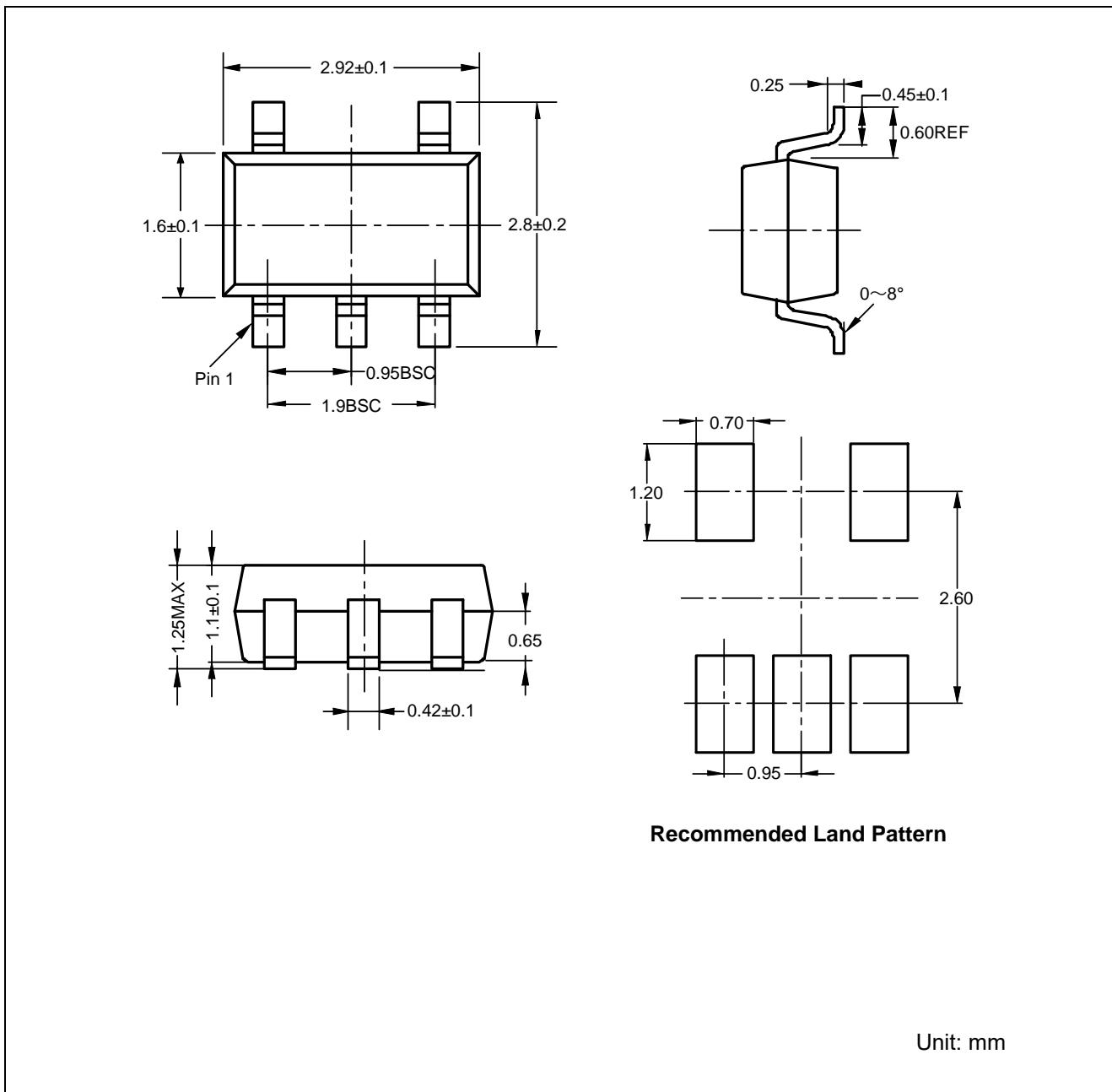
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SOT89-5



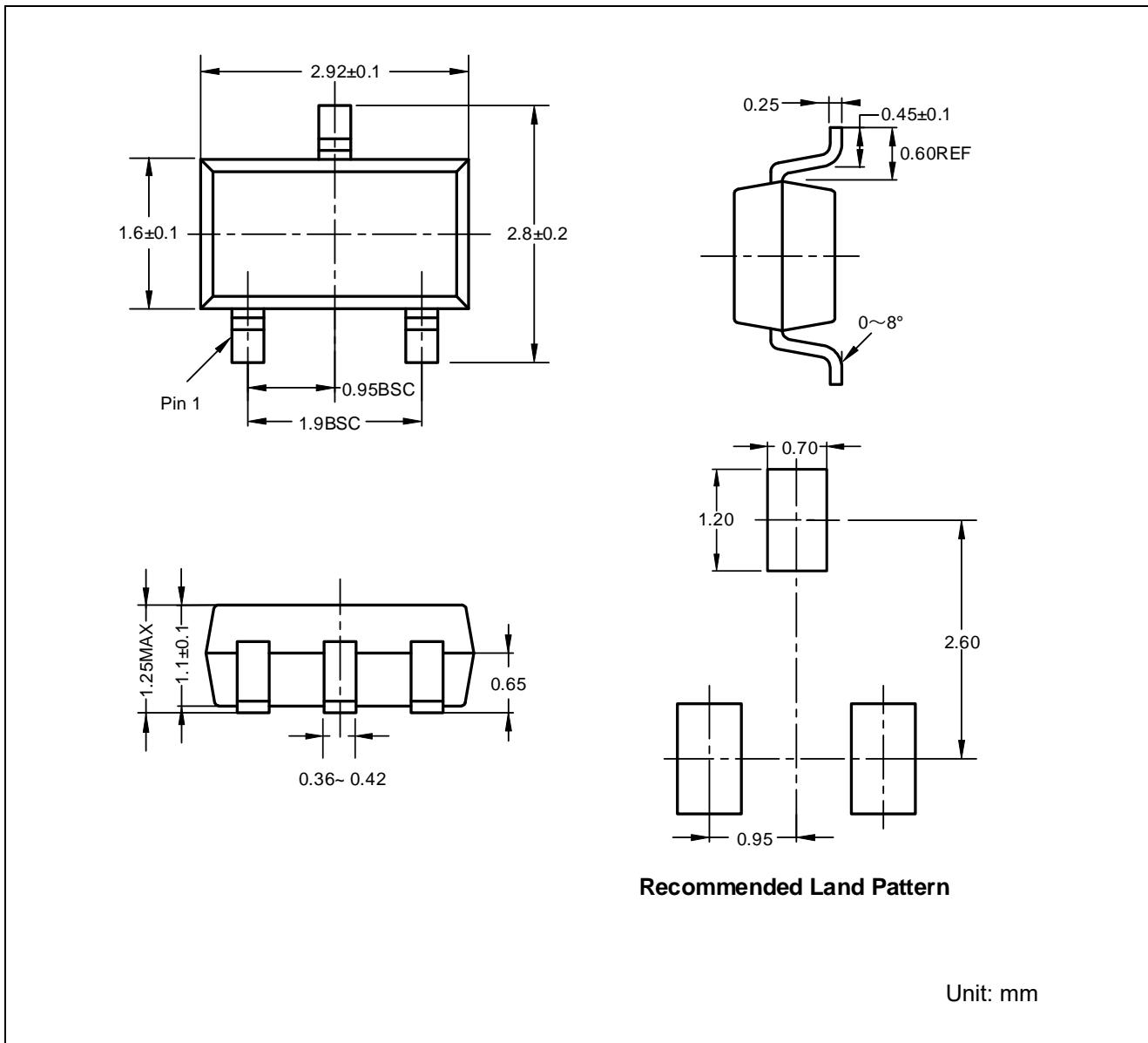
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SOT23-5



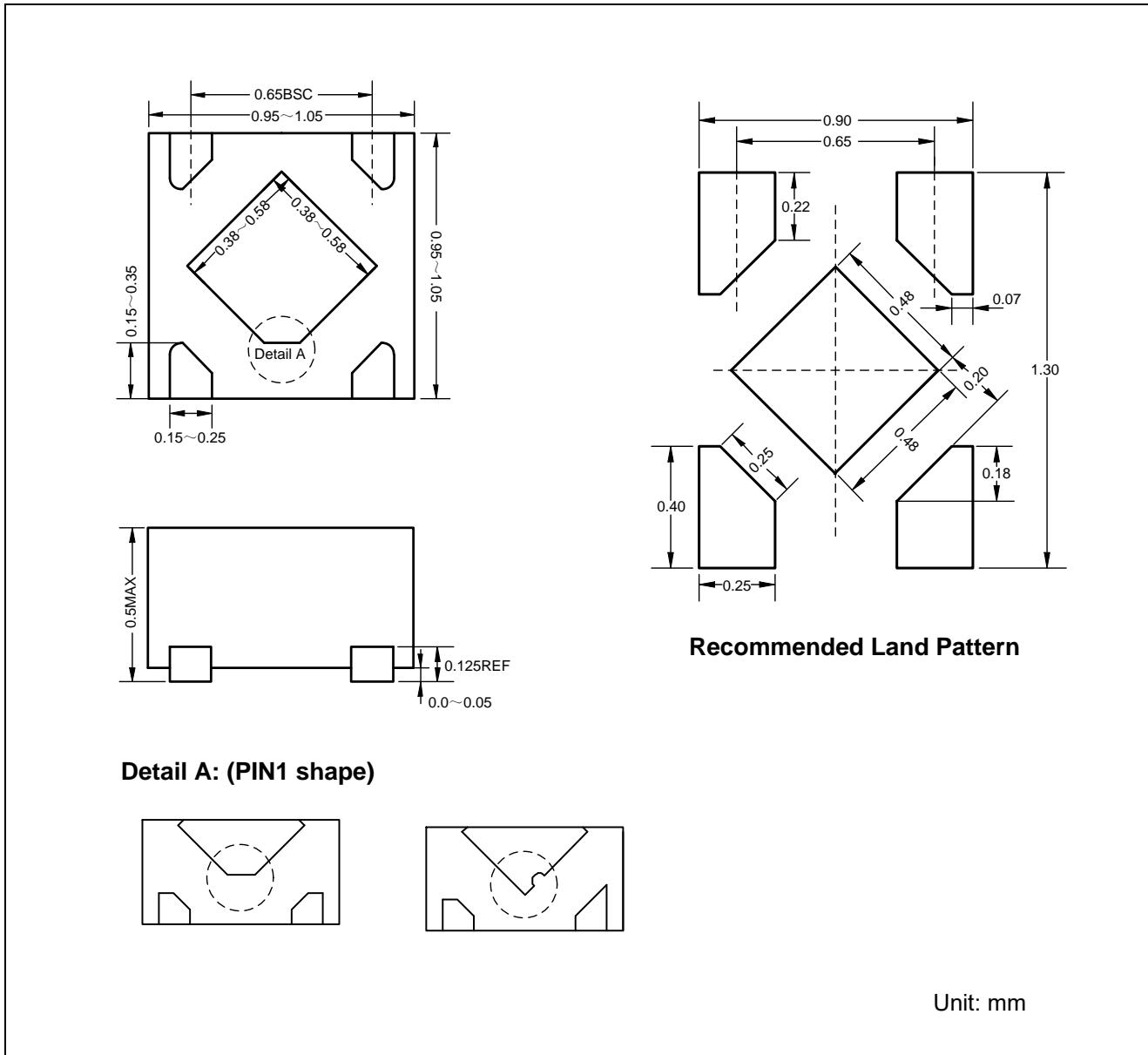
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SOT23-3



# ET5H4XX

DFN4(1x1)



## Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
0.0	2020-06-19	Preliminary Version	Liuxm	Liuxm	Zhujl
0.1	2023-09-09	Update to 500mA version	Yangxx	Liuxm	Liuwy
0.2	2025-04-23	Update Typical Characteristics	Pengjj	Liuxm	Liuwy
1.0	2025-06-18	Official Version	Pengjj	Liuxm	Liuwy
1.1	2025-06-18	Update B version	Shibo	Liuxm	Liuwy